

FDPF15N65 N-Channel UniFET[™] MOSFET

650 V, 15 A, 440 mΩ

Features

- $R_{DS(on)}$ = 440 m Ω (Max.) @ V_{GS} = 10 V, I_D = 7.5 A
- Low Gate Charge (Typ. 48.5 nC)
- Low C_{rss} (Typ. 23.6 pF)
- 100% Avalanche Tested

Applications

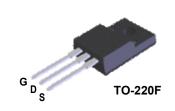
- LCD/LED/PDP TV and Monitor
- Uninterruptible Power Supply

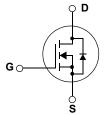




Description

UniFETTM MOSFET is Fairchild Semiconductor[®], s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





Absolute Maximum Ratings

Symbol	Parameter			FDPF15N65	Unit	
V _{DSS}	Drain-Source Voltage			650	V	
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		15* 9.5*	A A	
I _{DM}	Drain Current	- Pulsed (Note 1)		60*	А	
V _{GSS}	Gate-Source voltage			± 30	V	
E _{AS}	Single Pulsed Avalanche Energy		ngle Pulsed Avalanche Energy (Note 2) 633		mJ	
I _{AR}	Avalanche Current		(Note 1)	15	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	25.0	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		38.5 0.3	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

* Drain current limited by maximum junction termperature.

Thermal Characteristics

Symbol	Parameter	FDPF15N65	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	3.3	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	0,00	

Device Marking		Device Pa		ckage	ckage Reel Size Tap		e Width		Quantity	
FDPF1	FDPF15N65 FDPF15N65 T)-220F				50			
Electric	al Chai	racteristics T _c	; = 25°C unle	ess otherwise no	oted					
Symbol	Parameter		Conditions		Min	Тур	Max	Unit		
Off Charac	teristics			•						
BV _{DSS}	Drain-Sou	urce Breakdown Voltage		V _{GS} = 0V, I _D = 250μA, T _J = 25°C		650			V	
ΔΒV _{DSS} / ΔΤ _J		Breakdown Voltage Temperature Coefficient		$I_D = 250 \mu A$, Referenced to 25°C			0.65		V/°C	
I _{DSS}	Zero Gate	Zero Gate Voltage Drain Current		$V_{DS} = 650V, V_{GS} = 0V$ $V_{DS} = 520V, T_{C} = 125^{\circ}C$				1 10	μΑ μΑ	
I _{GSSF}	Gate-Bod	y Leakage Current, F	orward	V _{GS} = 30 ⁴	V, V _{DS} = 0V				100	nA
I _{GSSR}	Gate-Bod	y Leakage Current, R	Reverse	V _{GS} = -30	V, V _{DS} = 0V				-100	nA
On Charac	teristics									1
V _{GS(th)}	Gate Thre	eshold Voltage		V _{DS} = V _{GS} , I _D = 250μA		3.0		5.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 10V, I _D = 7.5A			0.36	0.44	Ω		
9 _{FS}	Forward 7	Transconductance		V _{DS} = 40V, I _D = 7.5A			19.2		S	
Dynamic C	haracteris	tics								
C _{iss}	Input Cap	acitance		$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz			2380	3095	pF	
C _{oss}	Output Ca	apacitance					295	385	pF	
C _{rss}	Reverse ⁻	e Transfer Capacitance					23.6	35.5	pF	
Switching	Characteri	istics							-	
t _{d(on)}	Turn-On Delay Time		$V_{DD} = 325V, I_D = 15A$			65	140	ns		
t _r	Turn-On F	Rise Time		$R_{G} = 21.7\Omega$			125	260	ns	
t _{d(off)}	Turn-Off	Delay Time						105	220	ns
t _f	Turn-Off F	Fall Time				(Note 4)		65	140	ns
Qg	Total Gate	e Charge		$V_{DS} = 520V, I_D = 15A$ $V_{GS} = 10V$ (Note 4)				48.5	63.0	nC
Q _{gs}	Gate-Sou	rce Charge					14.0		nC	
Q _{gd}	Gate-Drai	in Charge					21.2		nC	
Drain-Sour	ce Diode (Characteristics and	Maximur	n Ratings						
I _S	Maximum Continuous Drain-Source Diod			de Forward Current					15	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Fo		orward Current				60	Α		
V _{SD}	Drain-Sou	urce Diode Forward V	oltage	V _{GS} = 0V, I _S = 15A					1.4	V
t _{rr}	Reverse I	Recovery Time		$V_{GS} = 0V_{S}$				496		ns
Q _{rr}	Reverse F	Recovery Charge		dI _F /dt =10	0A/μs			5.69		μC

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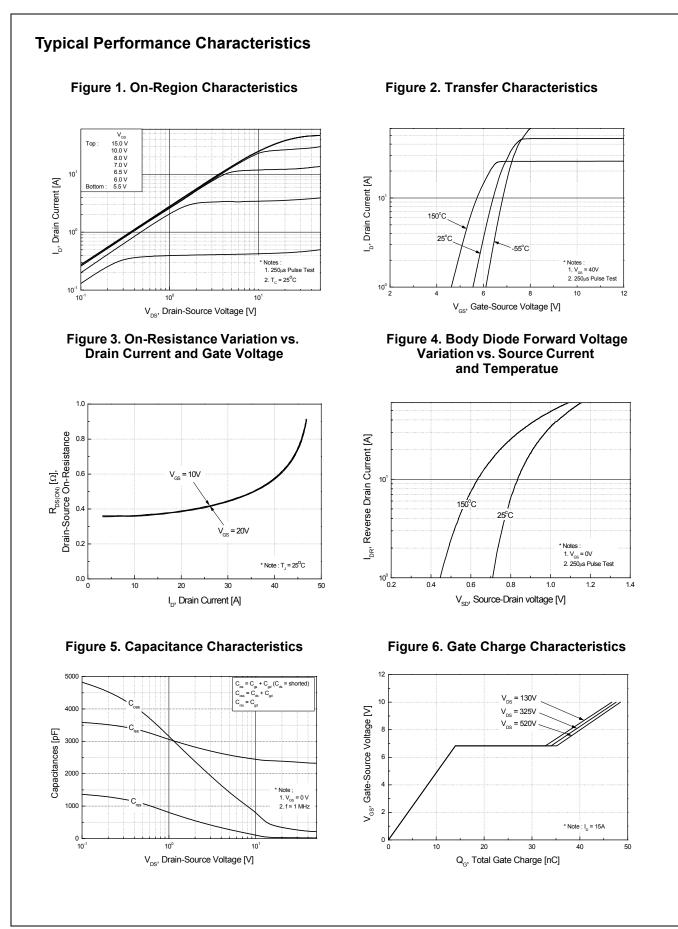
NOTES:

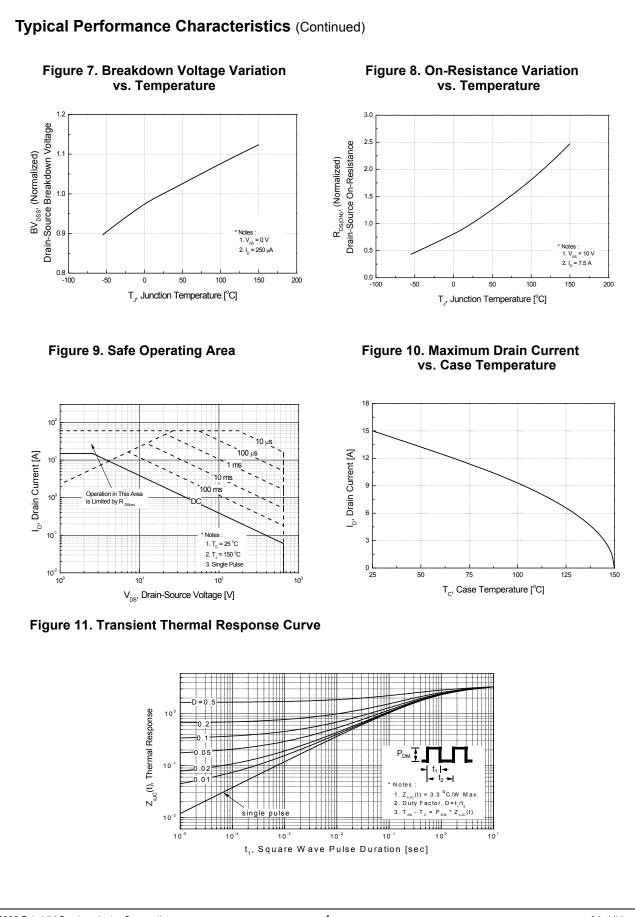
1. Repetitive Rating: Pulse width limited by maximum junction temperature

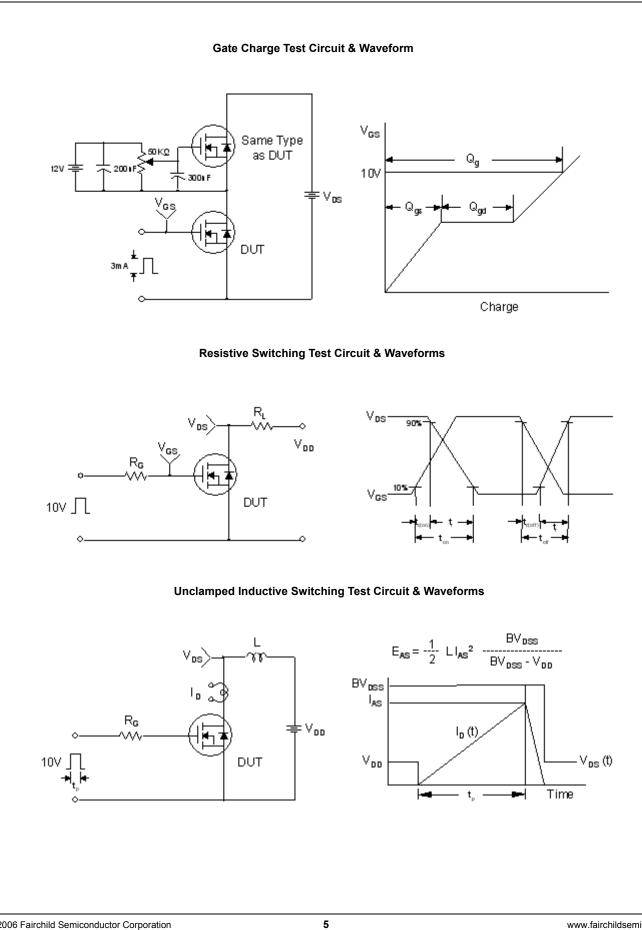
2. L = 5.23mH, I_{AS} = 15A, V_{DD} = 50V, R_G = 25\Omega, Starting T_J = 25°C

3. I_{SD} \leq 15A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

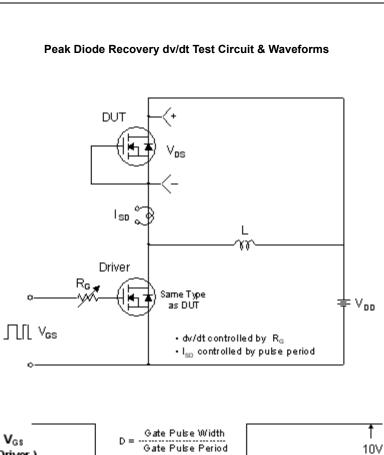
4. Essentially Independent of Operating Temperature Typical Characteristics

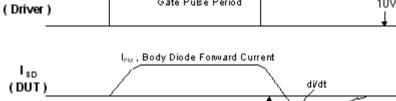




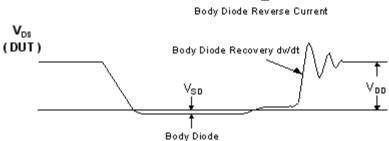


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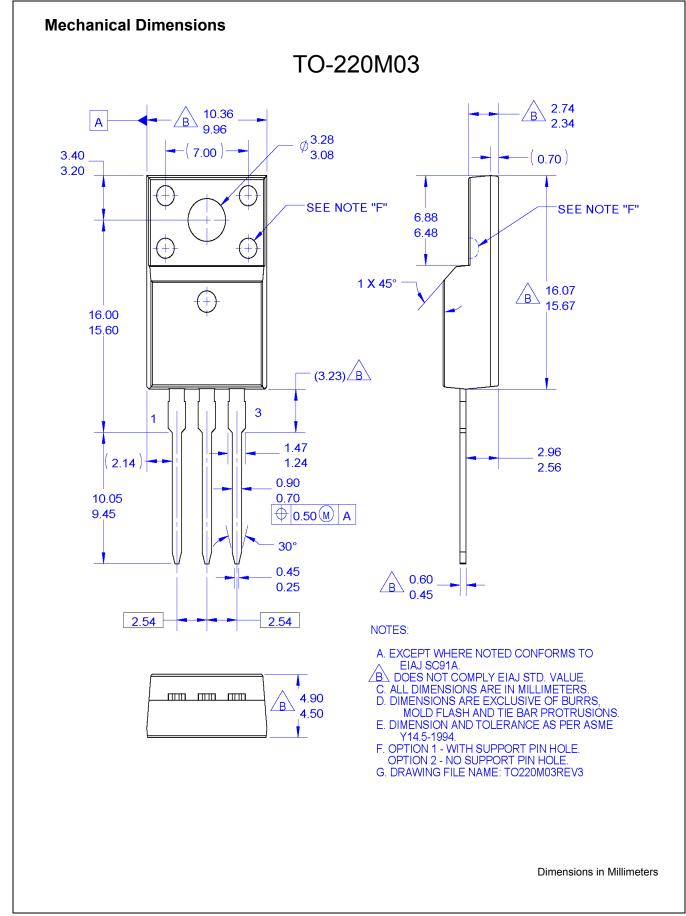


RM



Forward Voltage Drop







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